PE CONTRACTOR THE

#9/2W/Exp 482.

& IBEO'IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant:

Hshieh et al.

Serial No.:

10/010,484

Filed:

November 20, 2001

Title:

Trench MOSFET Device with Polycrystalline Silicon Source Contact Structure

Art Unit:

2826

Examiner:

Tan N. Tran

Docket No.:

GS 150

Assistant Commissioner for Patents Washington, D.C. 20231

AMENDMENT

Sir:

In response to the Office Action dated December 4, 2002 (Paper No. 8), kindly consider the following response. In addition, any deficiencies may be charged to deposit account No. 50-1047.

IN THE CLAIMS

Please amend Claims 1 and 16 as follows:

1. (Amended) A trench MOSFET transistor device comprising:

04/15/2003 DSASFAI 00000005 On substrate of a first conductivity type;

01 FC:1251

110.40 milicon epitaxial layer of said first conductivity type over said substrate, said epitaxial layer having a lower majority carrier concentration than said substrate;

a trench extending into said epitaxial layer from an upper surface of said epitaxial layer; an insulating layer lining at least a portion of said trench;